



**ALPHA & OMEGA**  
SEMICONDUCTOR

# AOD423/AOI423/AOY423

30V P-Channel MOSFET

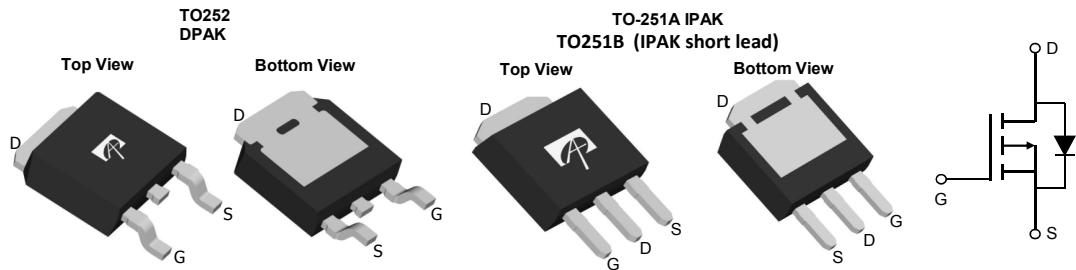
## General Description

The AOD423/AOI423/AOY423 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and low gate resistance. With the excellent thermal resistance of the DPAK/IPAK package, this device is well suited for high current load applications.

## Product Summary

$V_{DS}$	-30V
$I_D$ (at $V_{GS} = -20V$ )	-70A
$R_{DS(ON)}$ (at $V_{GS} = -20V$ )	< 6.2mΩ (< 6.7mΩ*)
$R_{DS(ON)}$ (at $V_{GS} = -10V$ )	< 8mΩ (< 8.5mΩ*)

100% UIS Tested  
100%  $R_g$  Tested



Orderable Part Number	Package Type	Form	Minimum Order Quantity
AOD423	TO-252	Tape & Reel	2500
AOI423	TO-251A	Tube	4000
AOY423	TO-251B	Tube	4000

## Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	$V_{DS}$	-30	V
Gate-Source Voltage	$V_{GS}$	$\pm 25$	V
Continuous Drain Current <sup>G</sup>	$I_D$	-70	A
$T_C=100^\circ C$		-67	
Pulsed Drain Current <sup>C</sup>	$I_{DM}$	-200	
Continuous Drain Current	$I_{DSM}$	-15	A
$T_A=70^\circ C$		-12	
Avalanche Current <sup>C</sup>	$I_{AS}, I_{AR}$	-50	A
Avalanche energy $L=0.1mH$ <sup>C</sup>	$E_{AS}, E_{AR}$	125	mJ
Power Dissipation <sup>B</sup>	$P_D$	90	W
$T_C=100^\circ C$		45	
Power Dissipation <sup>A</sup>	$P_{DSM}$	2.5	W
$T_A=70^\circ C$		1.6	
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to 175	°C

## Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient <sup>A</sup>	$R_{\theta JA}$	16	20	°C/W
Maximum Junction-to-Ambient <sup>A,D</sup>		41	50	°C/W
Maximum Junction-to-Case	$R_{\theta JC}$	0.9	1.6	°C/W

\* package TO251A, TO251B

**Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>STATIC PARAMETERS</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$I_D=-250\mu\text{A}, V_{GS}=0\text{V}$	-30			V
$\text{I}_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{DS}=-30\text{V}, V_{GS}=0\text{V}$ $T_J=55^\circ\text{C}$			-1 -5	$\mu\text{A}$
$\text{I}_{\text{GSS}}$	Gate-Body leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm 25\text{V}$			$\pm 100$	nA
$\text{V}_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=-250\mu\text{A}$	-1.5	-2.5	-3.5	V
$\text{I}_{\text{D(ON)}}$	On state drain current	$V_{GS}=-10\text{V}, V_{DS}=-5\text{V}$	-200			A
$\text{R}_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{GS}=-20\text{V}, I_D=-20\text{A}$ TO252 $T_J=125^\circ\text{C}$		5.1	6.2	$\text{m}\Omega$
		$V_{GS}=-10\text{V}, I_D=-20\text{A}$ TO252		7.6	9.2	
		$V_{GS}=-20\text{V}, I_D=-20\text{A}$ TO251A, TO251B		6.2	8	$\text{m}\Omega$
		$V_{GS}=-10\text{V}, I_D=-20\text{A}$ TO251A, TO251B		5.6	6.7	$\text{m}\Omega$
$\text{g}_{\text{FS}}$	Forward Transconductance	$V_{DS}=-5\text{V}, I_D=-20\text{A}$		42		S
$\text{V}_{\text{SD}}$	Diode Forward Voltage	$I_S=-1\text{A}, V_{GS}=0\text{V}$		-0.7	-1	V
$\text{I}_S$	Maximum Body-Diode Continuous Current <sup>G</sup>				-70	A
<b>DYNAMIC PARAMETERS</b>						
$\text{C}_{\text{iss}}$	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=-15\text{V}, f=1\text{MHz}$		2760		pF
$\text{C}_{\text{oss}}$	Output Capacitance			550		pF
$\text{C}_{\text{rss}}$	Reverse Transfer Capacitance			375		pF
$\text{R}_g$	Gate resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$	1.5	3	6.0	$\Omega$
<b>SWITCHING PARAMETERS</b>						
$\text{Q}_g$	Total Gate Charge	$V_{GS}=-10\text{V}, V_{DS}=-15\text{V}, I_D=-20\text{A}$		45	65	nC
$\text{Q}_{\text{gs}}$	Gate Source Charge			10		nC
$\text{Q}_{\text{gd}}$	Gate Drain Charge			12		nC
$t_{\text{D(on)}}$	Turn-On DelayTime	$V_{GS}=-10\text{V}, V_{DS}=-15\text{V}, R_L=0.75\Omega, R_{\text{GEN}}=3\Omega$		13		ns
$t_r$	Turn-On Rise Time			23		ns
$t_{\text{D(off)}}$	Turn-Off DelayTime			35		ns
$t_f$	Turn-Off Fall Time			26		ns
$t_{\text{rr}}$	Body Diode Reverse Recovery Time	$I_F=-20\text{A}, dI/dt=500\text{A}/\mu\text{s}$		15		ns
$\text{Q}_{\text{rr}}$	Body Diode Reverse Recovery Charge	$I_F=-20\text{A}, dI/dt=500\text{A}/\mu\text{s}$		30		nC

A. The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The Power dissipation  $P_{\text{DSM}}$  is based on  $R_{\theta JA}$  and the maximum allowed junction temperature of  $150^\circ\text{C}$ . The value in any given application depends on the user's specific board design, and the maximum temperature of  $175^\circ\text{C}$  may be used if the PCB allows it.

B. The power dissipation  $P_D$  is based on  $T_{J(\text{MAX})}=175^\circ\text{C}$ , using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Repetitive rating, pulse width limited by junction temperature  $T_{J(\text{MAX})}=175^\circ\text{C}$ . Ratings are based on low frequency and duty cycles to keep initial  $T_J=25^\circ\text{C}$ .

D. The  $R_{\theta JA}$  is the sum of the thermal impedance from junction to case  $R_{\theta JC}$  and case to ambient.

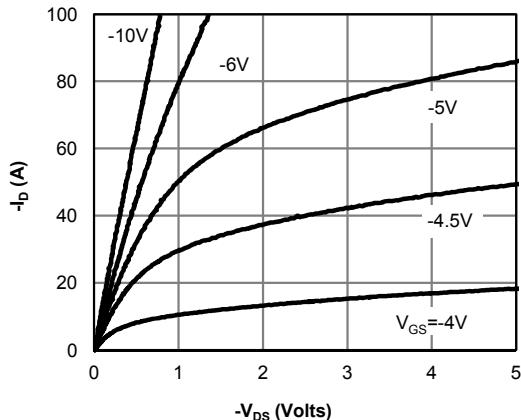
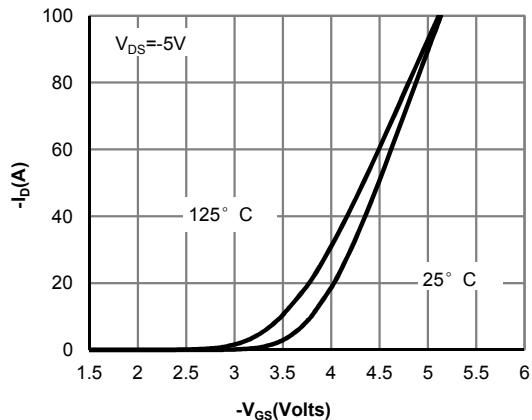
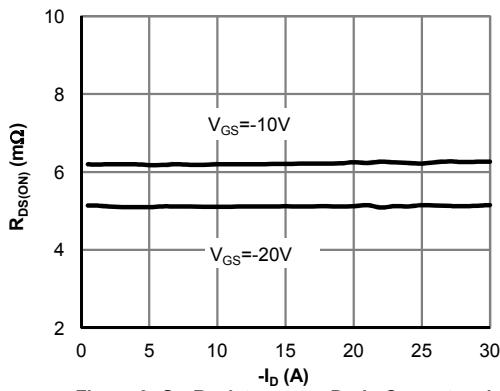
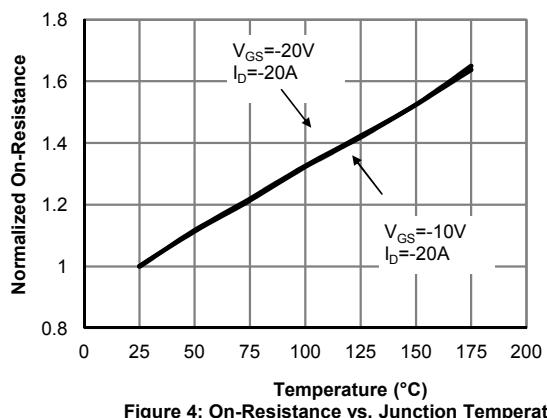
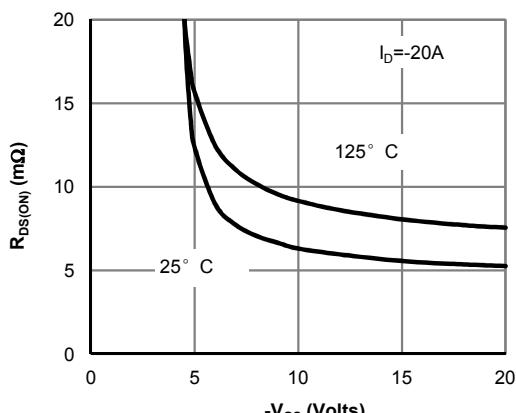
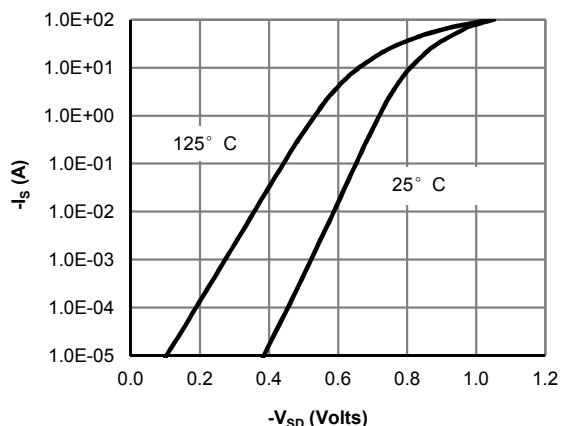
E. The static characteristics in Figures 1 to 6 are obtained using  $<300\mu\text{s}$  pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of  $T_{J(\text{MAX})}=175^\circ\text{C}$ . The SOA curve provides a single pulse rating.

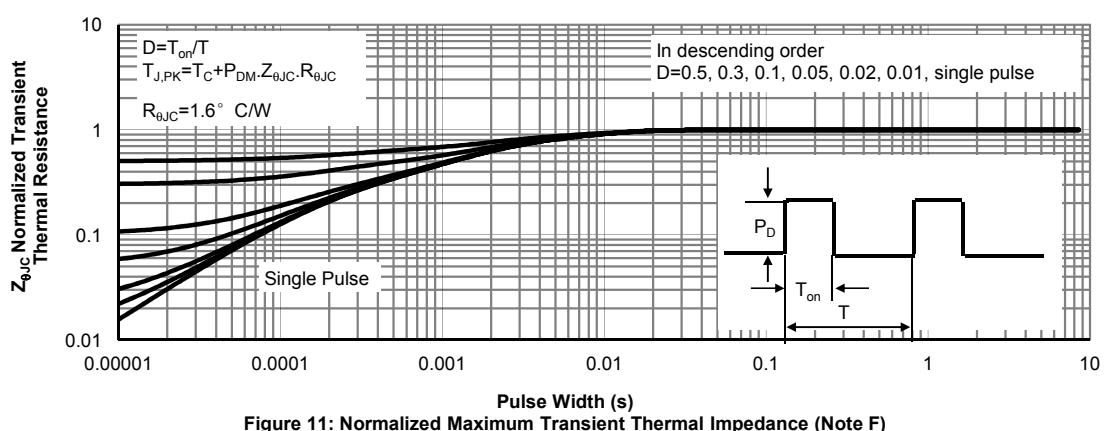
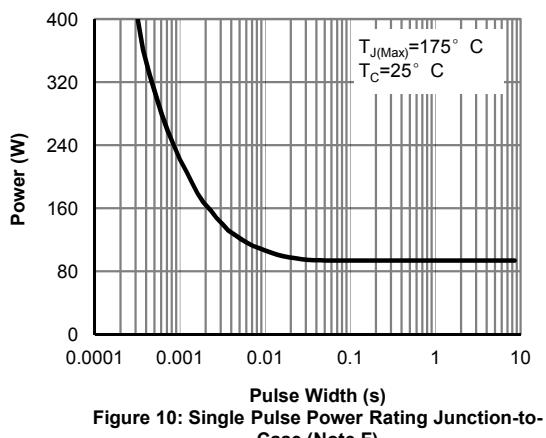
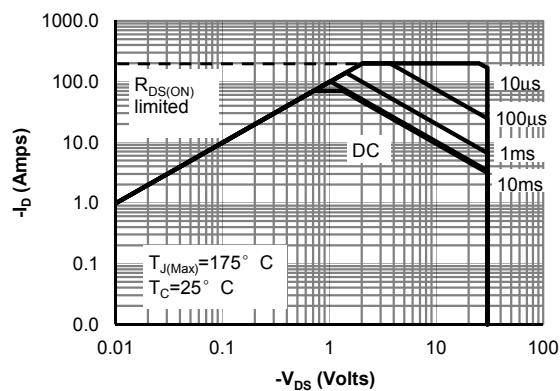
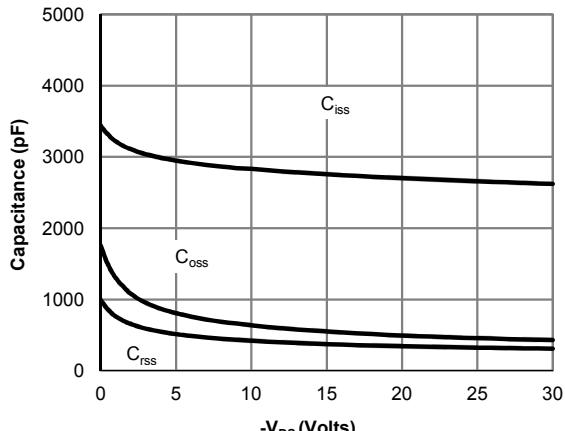
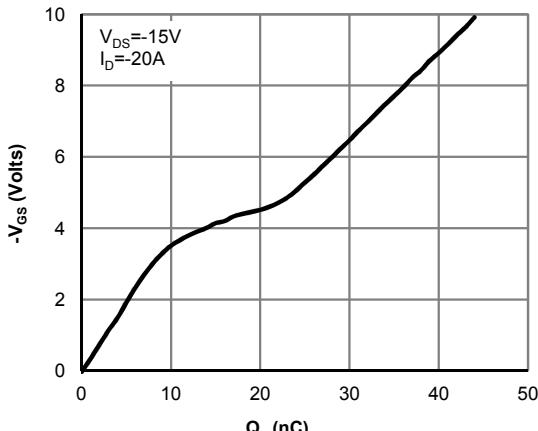
G. The maximum current rating is package limited.

H. These tests are performed with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ .

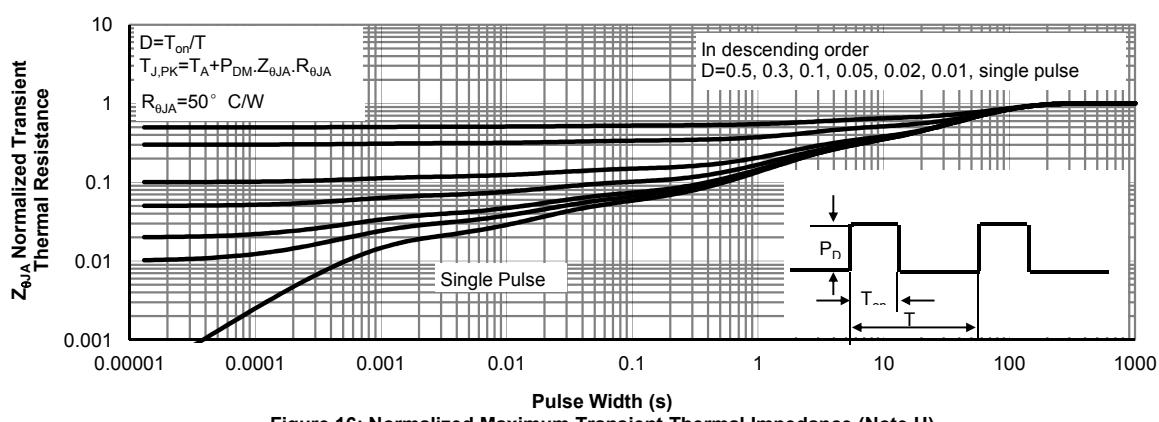
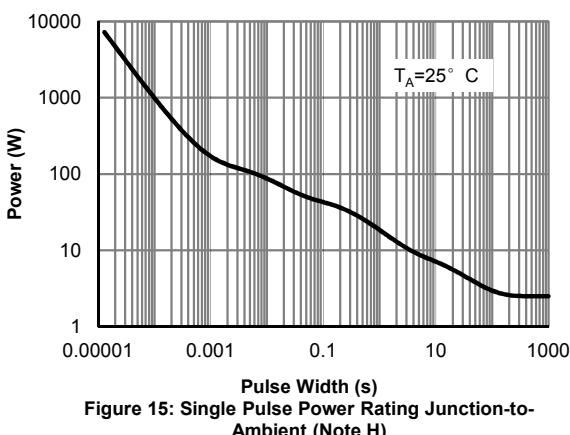
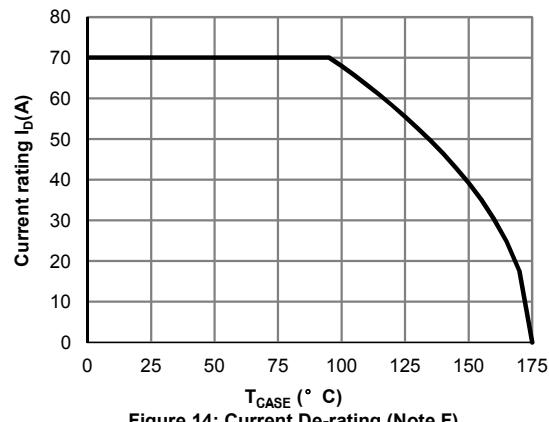
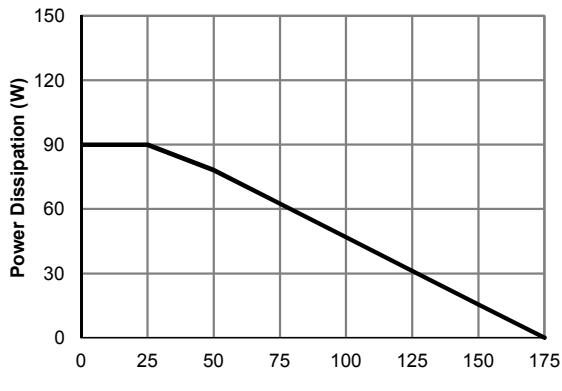
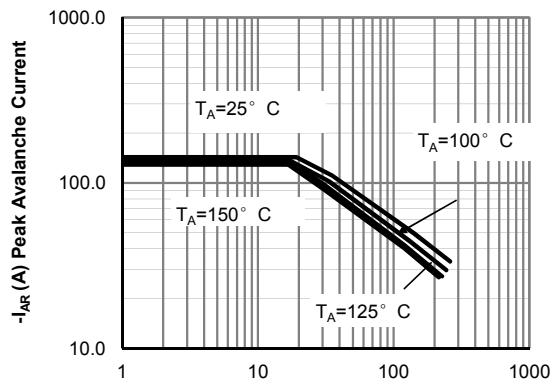
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**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**

**Fig 1: On-Region Characteristics (Note E)**

**Figure 2: Transfer Characteristics (Note E)**

**Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)**

**Figure 4: On-Resistance vs. Junction Temperature (Note E)**

**Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)**

**Figure 6: Body-Diode Characteristics (Note E)**

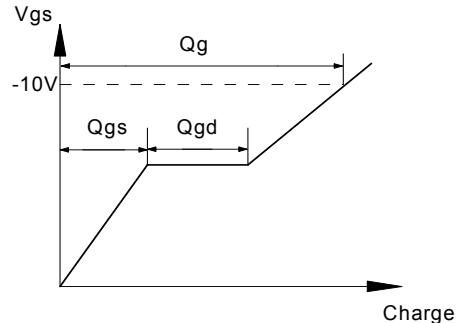
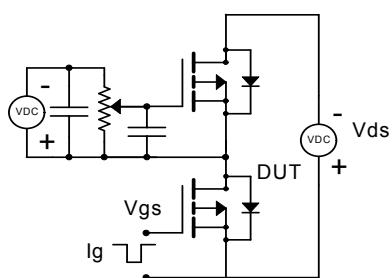
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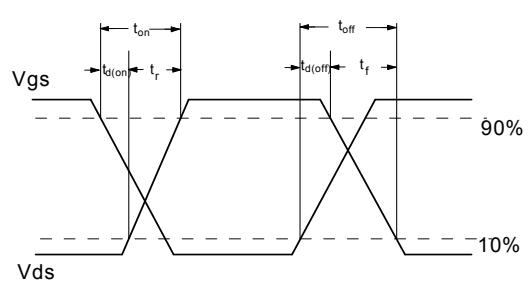
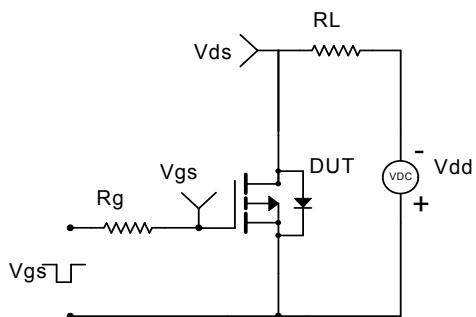
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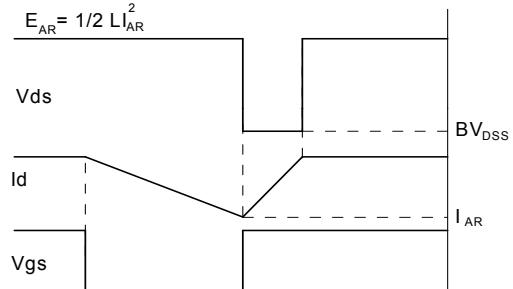
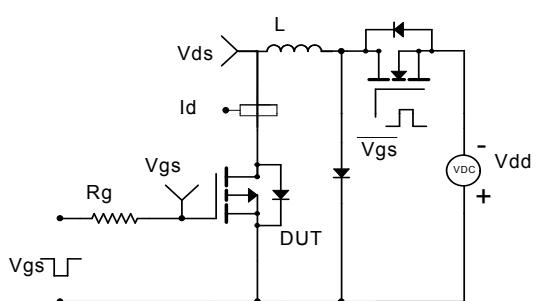
Gate Charge Test Circuit & Waveform



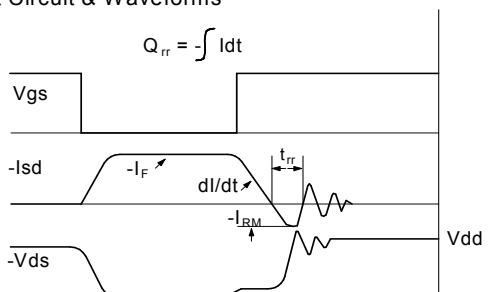
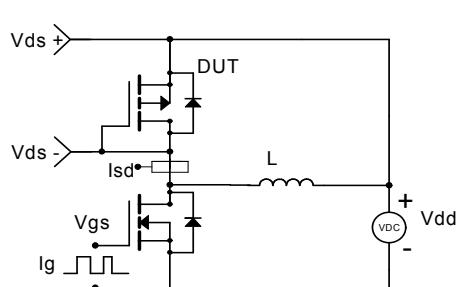
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